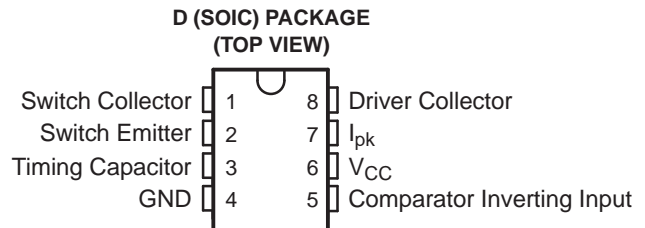


## 1.5-A PEAK BOOST/BUCK/INVERTING SWITCHING REGULATOR

### FEATURES

- Qualified for Automotive Applications
- Wide Input Voltage Range...3 V to 40 V
- High Output Switch Current...Up to 1.5 A
- Adjustable Output Voltage
- Oscillator Frequency...Up to 100 kHz
- Precision Internal Reference...2%
- Short-Circuit Current Limiting
- Low Standby Current



### DESCRIPTION/ORDERING INFORMATION

The MC33063A is an easy-to-use IC containing all the primary circuitry needed for building simple dc-dc converters. The device primarily consists of an internal temperature-compensated reference, a comparator, an oscillator, a PWM controller with active current limiting, a driver, and a high-current output switch. Thus, the device requires minimal external components to build converters in the boost, buck, and inverting topologies.

The MC33063A is characterized for operation from  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ .

#### ORDERING INFORMATION<sup>(1)</sup>

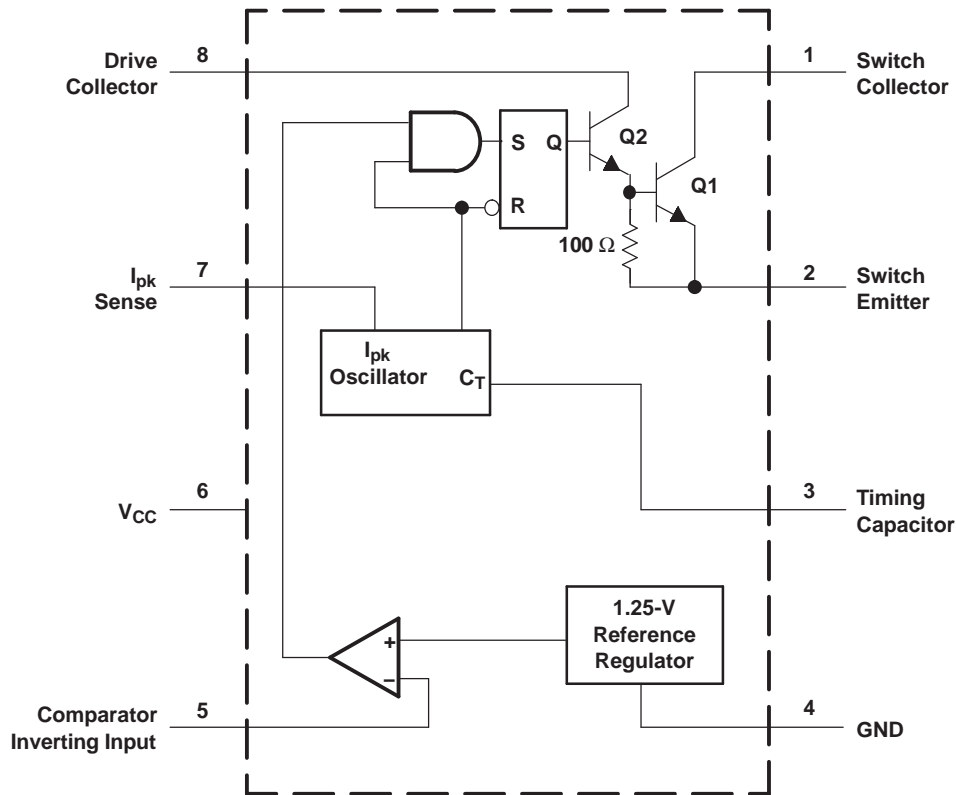
| $T_A$  | PACKAGE <sup>(2)</sup> |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|--|------------------------|--------------|-----------------------|------------------|
| $-40^{\circ}\text{C}$ to $125^{\circ}\text{C}$ | SOIC – D               | Reel of 2500 | MC33063AQDRQ1         | 33063AQ          |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**FUNCTIONAL BLOCK DIAGRAM**



**Absolute Maximum Ratings<sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

|                         |   |                          |
|-------------------------|---|--------------------------|
| V <sub>CC</sub>         | Supply voltage                              | 40 V                     |
| V <sub>IR</sub>         | Comparator Inverting Input voltage range    | -0.3 V to 40 V           |
| V <sub>C(switch)</sub>  | Switch Collector voltage                    | 40 V                     |
| V <sub>E(switch)</sub>  | Switch Emitter voltage                      | V <sub>PIN1</sub> = 40 V |
| V <sub>CE(switch)</sub> | Switch Collector to Switch Emitter voltage  | 40 V                     |
| V <sub>C(driver)</sub>  | Driver Collector voltage                    | 40 V                     |
| I <sub>C(driver)</sub>  | Driver Collector current                    | 100 mA                   |
| I <sub>SW</sub>         | Switch current                              | 1.5 A                    |
| θ <sub>JA</sub>         | Package thermal impedance <sup>(2)(3)</sup> | 97°C/W                   |
| T <sub>J</sub>          | Operating virtual junction temperature      | 150°C                    |
| T <sub>stg</sub>        | Storage temperature range                   | -65°C to 150°C           |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Maximum power dissipation is a function of T<sub>J(max)</sub>, θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J(max)</sub> - T<sub>A</sub>)/θ<sub>JA</sub>. Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.

**Recommended Operating Conditions**

|                 |                                | MIN | MAX | UNIT |
|-----------------|--------------------------------|-----|-----|------|
| V <sub>CC</sub> | Supply voltage                 | 3   | 40  | V    |
| T <sub>A</sub>  | Operating free-air temperature | -40 | 125 | °C   |

## Electrical Characteristics

$V_{CC} = 5\text{ V}$ ,  $T_A =$  full operating range (unless otherwise noted) (see block diagram)

### Oscillator

| PARAMETER            |                                   | TEST CONDITIONS                               | $T_A$ | MIN | TYP | MAX | UNIT |
|----------------------|-----------------------------------|---|-------|-----|-----|-----|------|
| $f_{osc}$            | Oscillator frequency              | $V_{PIN5} = 0\text{ V}$ , $C_T = 1\text{ nF}$ | 25°C  | 24  | 33  | 42  | kHz  |
| $I_{chg}$            | Charge current                    | $V_{CC} = 5\text{ V to }40\text{ V}$          | 25°C  | 24  | 35  | 42  | μA   |
| $I_{dischg}$         | Discharge current                 | $V_{CC} = 5\text{ V to }40\text{ V}$          | 25°C  | 140 | 220 | 260 | μA   |
| $I_{dischg}/I_{chg}$ | Discharge-to-charge current ratio | $V_{PIN7} = V_{CC}$                           | 25°C  | 5.2 | 6.5 | 7.5 |      |
| $V_{Ipk}$            | Current-limit sense voltage       | $I_{dischg} = I_{chg}$                        | 25°C  | 250 | 300 | 350 | mV   |

### Output Switch<sup>(1)</sup>

| PARAMETER     |   | TEST CONDITIONS  | $T_A$      | MIN | TYP  | MAX | UNIT |
|---------------|---|--|------------|-----|------|-----|------|
| $V_{CE(sat)}$ | Saturation voltage – Darlington connection                    | $I_{SW} = 1\text{ A}$ , pins 1 and 8 connected                                       | Full range |     | 1    | 1.3 | V    |
| $V_{CE(sat)}$ | Saturation voltage – non-Darlington connection <sup>(2)</sup> | $I_{SW} = 1\text{ A}$ , $R_{PIN8} = 82\ \Omega$ to $V_{CC}$ , Forced $\beta \sim 20$ | Full range |     | 0.45 | 0.7 | V    |
| $h_{FE}$      | DC current gain   | $I_{SW} = 1\text{ A}$ , $V_{CE} = 5\text{ V}$  | 25°C       | 50  | 75   |     |      |
| $I_{C(off)}$  | Collector off-state current                                   | $V_{CE} = 40\text{ V}$   | Full range |     | 0.01 | 100 | μA   |

(1) Low duty-cycle pulse testing is used to maintain junction temperature as close to ambient temperature as possible.

(2) In the non-Darlington configuration, if the output switch is driven into hard saturation at low switch currents ( $\leq 300\text{ mA}$ ) and high driver currents ( $\geq 30\text{ mA}$ ), it may take up to  $2\ \mu\text{s}$  for the switch to come out of saturation. This condition effectively shortens the off time at frequencies  $\geq 30\text{ kHz}$ , becoming magnified as temperature increases. The following output drive condition is recommended in the non-Darlington configuration:

Forced  $\beta$  of output switch =  $I_{C,SW} / (I_{C,driver} - 7\text{ mA}) \geq 10$ , where  $-7\text{ mA}$  is required by the  $100\text{-}\Omega$  resistor in the emitter of the driver to forward bias the  $V_{be}$  of the switch.

### Comparator

| PARAMETER       |                                   | TEST CONDITIONS                      | $T_A$      | MIN   | TYP  | MAX   | UNIT |
|-----------------|-----------------------------------|--------------------------------------|------------|-------|------|-------|------|
| $V_{th}$        | Threshold voltage                 |                                      | 25°C       | 1.225 | 1.25 | 1.275 | V    |
|                 |                                   |                                      | Full range | 1.21  |      | 1.29  |      |
| $\Delta V_{th}$ | Threshold-voltage line regulation | $V_{CC} = 5\text{ V to }40\text{ V}$ | Full range |       | 1.4  | 5     | mV   |
| $I_{IB}$        | Input bias current                | $V_{IN} = 0\text{ V}$                | Full range |       | -20  | -400  | nA   |

### Total Device

| PARAMETER |                | TEST CONDITIONS  | $T_A$      | MIN | MAX | UNIT |
|-----------|----------------|--|------------|-----|-----|------|
| $I_{CC}$  | Supply current | $V_{CC} = 5\text{ V to }40\text{ V}$ , $C_T = 1\text{ nF}$ ,<br>$V_{PIN7} = V_{CC}$ , $V_{PIN5} > V_{th}$ ,<br>$V_{PIN2} = \text{GND}$ , All other pins open | Full range |     | 4   | mA   |

TYPICAL CHARACTERISTICS

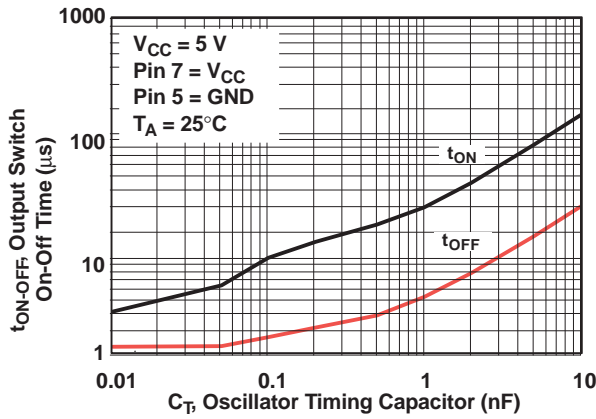


Figure 1. Output Switch On-Off Time vs Oscillator Timing Capacitor

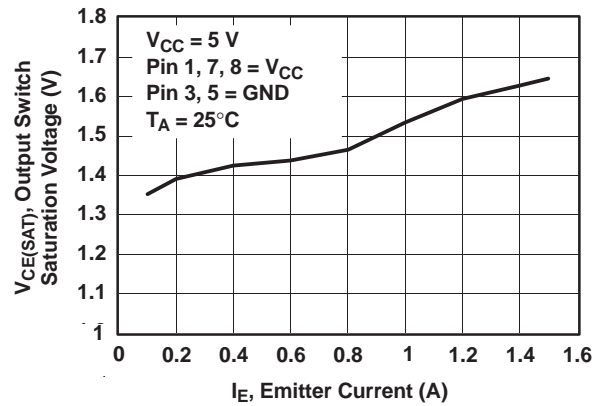


Figure 2. Output Switch Saturation Voltage vs Emitter Current (Emitter-Follower Configuration)

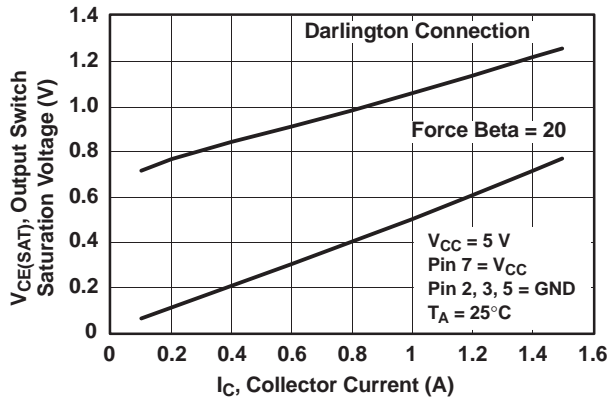


Figure 3. Output Switch Saturation Voltage vs Collector Current (Common-Emitter Configuration)

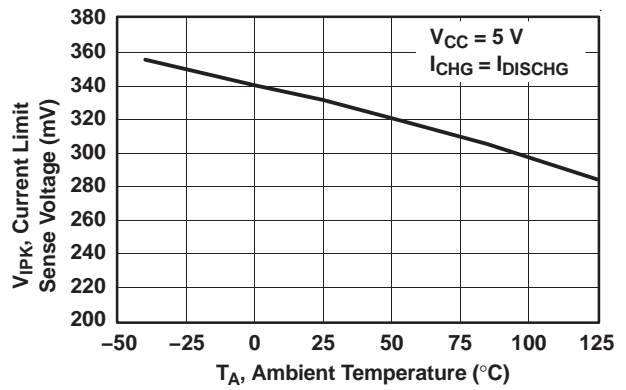


Figure 4. Current-Limit Sense Voltage vs Temperature

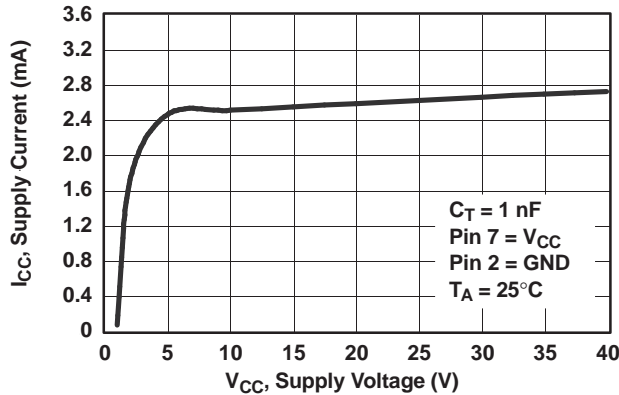


Figure 5. Standby Supply Current vs Supply Voltage

TYPICAL CHARACTERISTICS (continued)

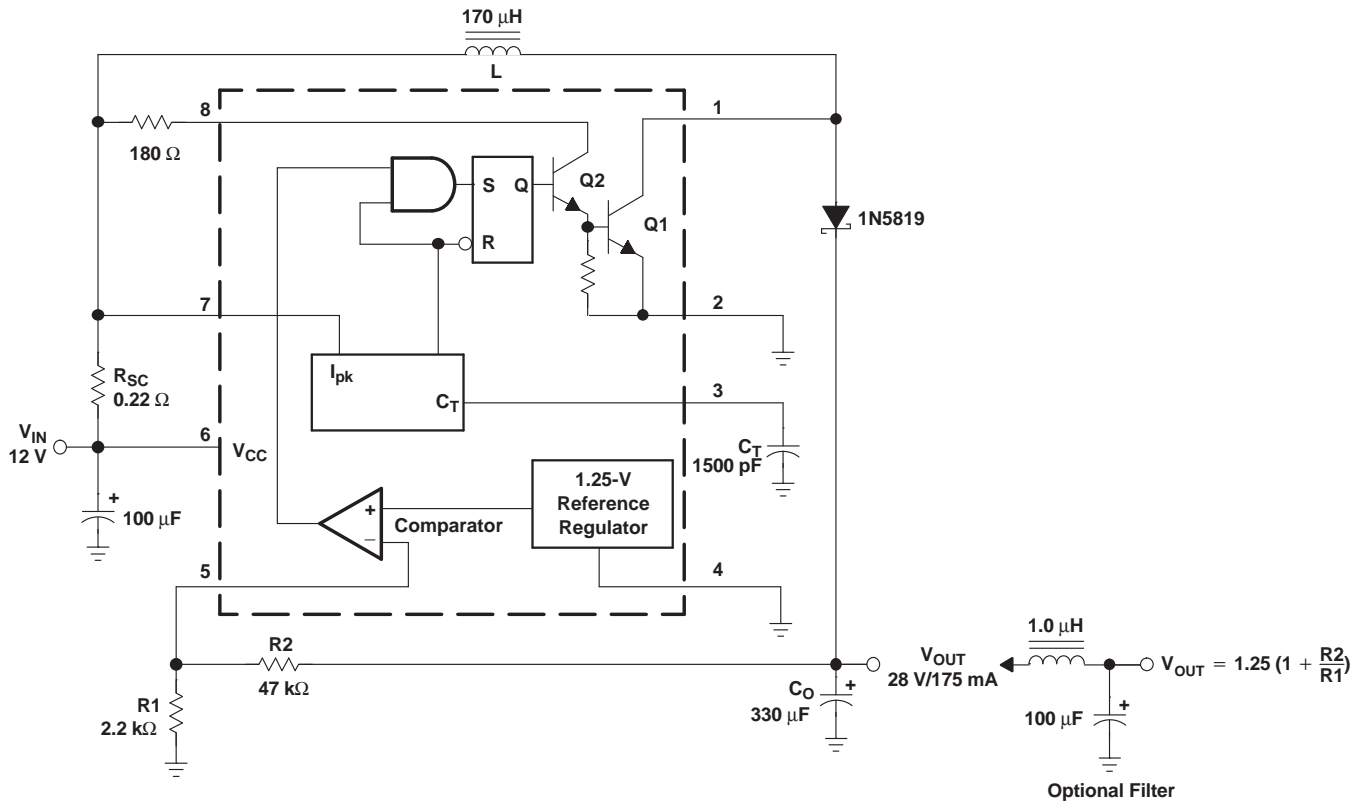
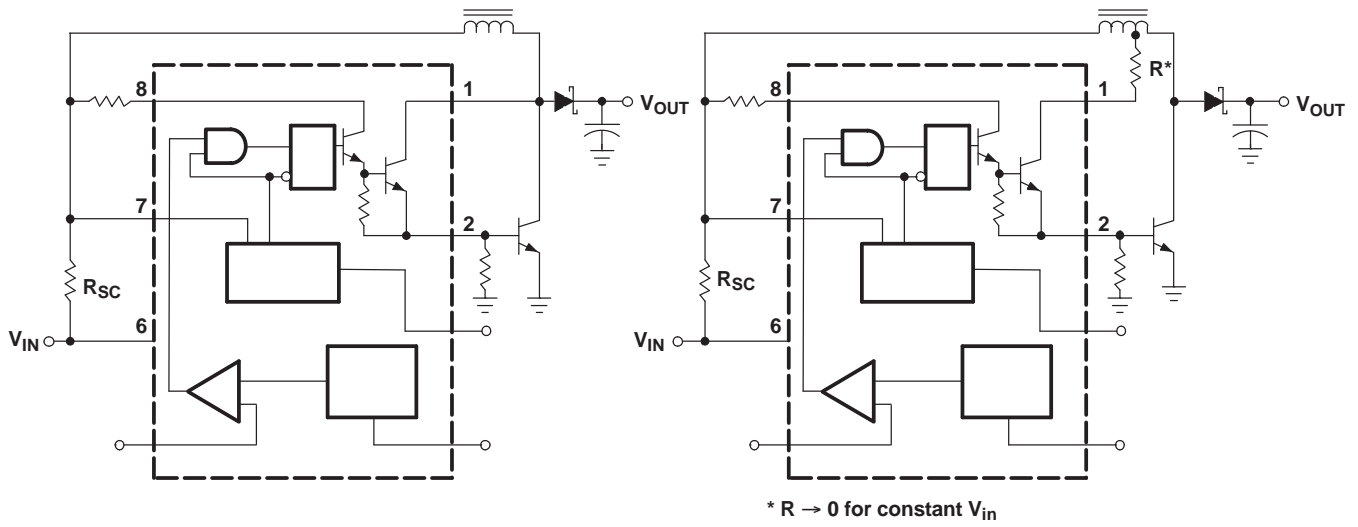


Figure 6. Step-Up Converter

| TEST                               | CONDITIONS   | RESULTS              |
|------------------------------------|--|----------------------|
| Line regulation                    | $V_{IN} = 8 \text{ V to } 16 \text{ V}$ , $I_O = 175 \text{ mA}$   | 30 mV $\pm$ 0.05%    |
| Load regulation                    | $V_{IN} = 12 \text{ V}$ , $I_O = 75 \text{ mA to } 175 \text{ mA}$ | 10 mV $\pm$ 0.017%   |
| Output ripple                      | $V_{IN} = 12 \text{ V}$ , $I_O = 175 \text{ mA}$                   | 400 mV <sub>PP</sub> |
| Efficiency                         | $V_{IN} = 12 \text{ V}$ , $I_O = 175 \text{ mA}$                   | 87.7%                |
| Output ripple with optional filter | $V_{IN} = 12 \text{ V}$ , $I_O = 175 \text{ mA}$                   | 40 mV <sub>PP</sub>  |



a) EXTERNAL npn SWITCH

b) EXTERNAL pnp SATURATED SWITCH (see Note A)

- A. If the output switch is driven into hard saturation (non-Darlington configuration) at low switch currents ( $\leq 300$  mA) and high driver currents ( $\geq 30$  mA), it may take up to  $2 \mu\text{s}$  to come out of saturation. This condition will shorten the off time at frequencies  $\geq 30$  kHz and is magnified at high temperatures. This condition does not occur with a Darlington configuration because the output switch cannot saturate. If a non-Darlington configuration is used, the output drive configuration in Figure 7b is recommended.

**Figure 7. External Current-Boost Connections for  $I_C$  Peak Greater Than 1.5 A**

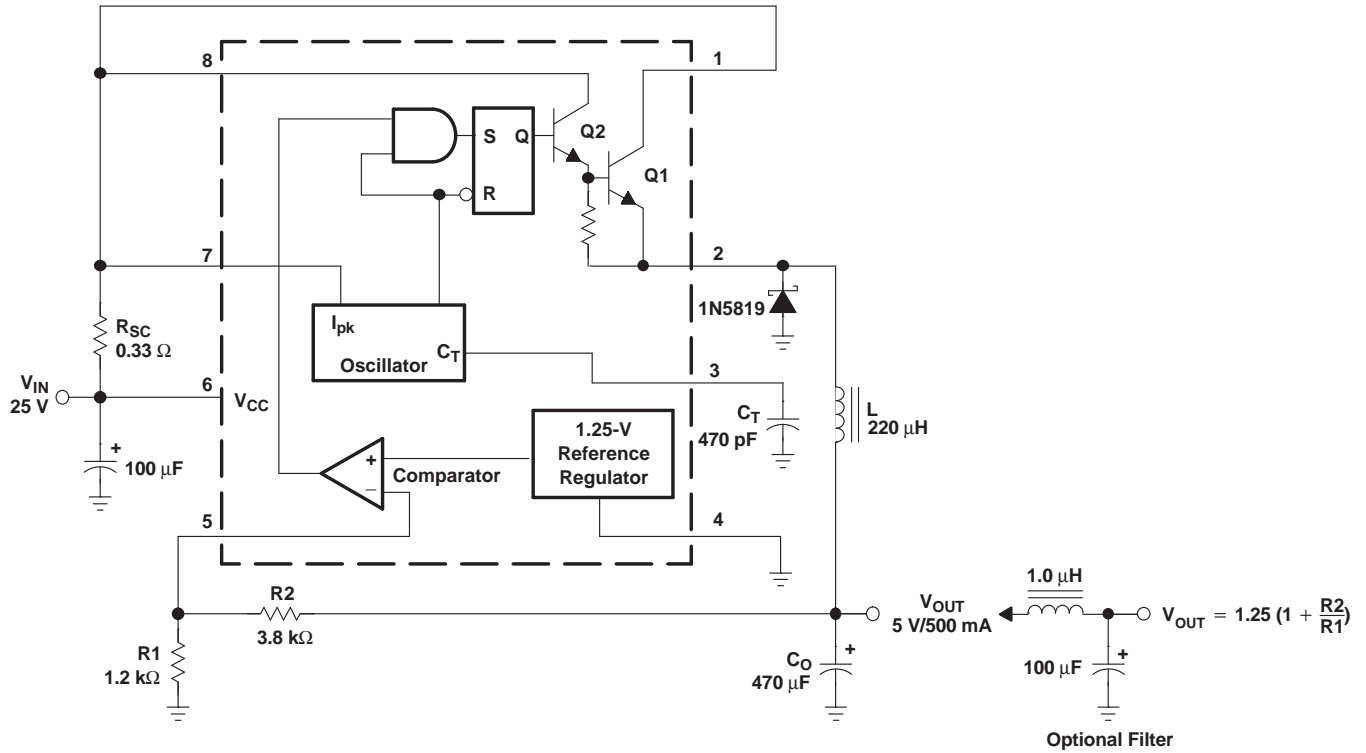


Figure 8. Step-Down Converter

| TEST                               | CONDITIONS  | RESULTS                   |
|------------------------------------|---|---------------------------|
| Line regulation                    | $V_{IN} = 15\text{ V to }25\text{ V}, I_O = 500\text{ mA}$  | $12\text{ mV} \pm 0.12\%$ |
| Load regulation                    | $V_{IN} = 25\text{ V}, I_O = 50\text{ mA to }500\text{ mA}$ | $3\text{ mV} \pm 0.03\%$  |
| Output ripple                      | $V_{IN} = 25\text{ V}, I_O = 500\text{ mA}$                 | $120\text{ mV}_{PP}$      |
| Short-circuit current              | $V_{IN} = 25\text{ V}, R_L = 0.1\ \Omega$                   | $1.1\text{ A}$            |
| Efficiency                         | $V_{IN} = 25\text{ V}, I_O = 500\text{ mA}$                 | $83.7\%$                  |
| Output ripple with optional filter | $V_{IN} = 25\text{ V}, I_O = 500\text{ mA}$                 | $40\text{ mV}_{PP}$       |

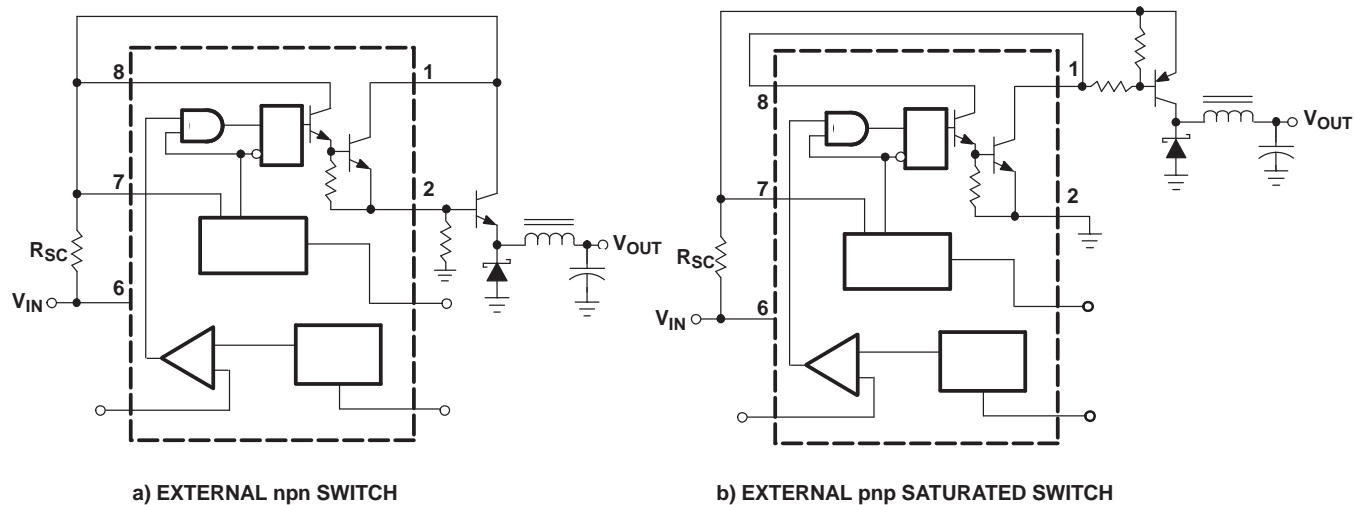


Figure 9. External Current-Boost Connections for  $I_C$  Peak Greater Than 1.5 A



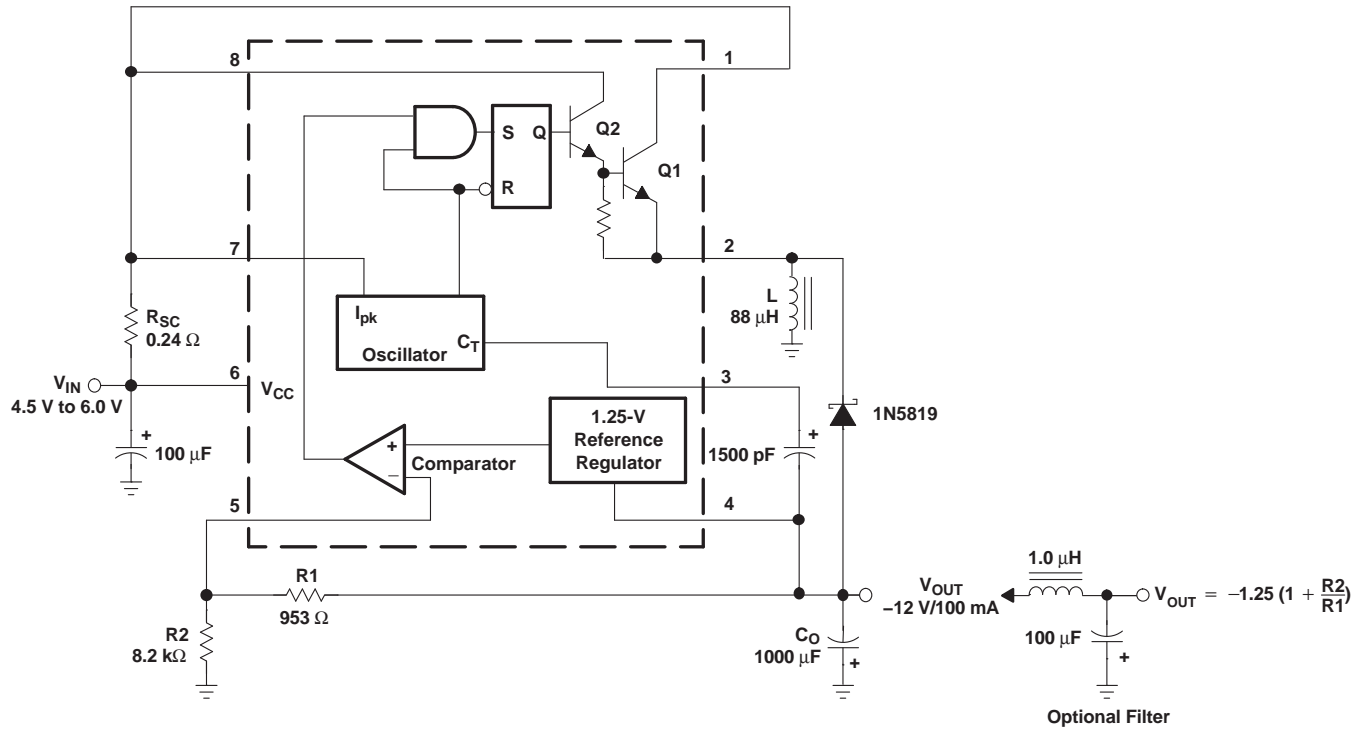


Figure 10. Voltage-Inverting Converter

| TEST                               | CONDITIONS   | RESULTS                      |
|------------------------------------|--|------------------------------|
| Line regulation                    | $V_{IN} = 4.5 \text{ V to } 6 \text{ V}, I_O = 100 \text{ mA}$ | $3 \text{ mV} \pm 0.12\%$    |
| Load regulation                    | $V_{IN} = 5 \text{ V}, I_O = 10 \text{ mA to } 100 \text{ mA}$ | $0.022 \text{ V} \pm 0.09\%$ |
| Output ripple                      | $V_{IN} = 5 \text{ V}, I_O = 100 \text{ mA}$                   | $500 \text{ mV}_{PP}$        |
| Short-circuit current              | $V_{IN} = 5 \text{ V}, R_L = 0.1 \Omega$                       | $910 \text{ mA}$             |
| Efficiency                         | $V_{IN} = 5 \text{ V}, I_O = 100 \text{ mA}$                   | $62.2\%$                     |
| Output ripple with optional filter | $V_{IN} = 5 \text{ V}, I_O = 100 \text{ mA}$                   | $70 \text{ mV}_{PP}$         |

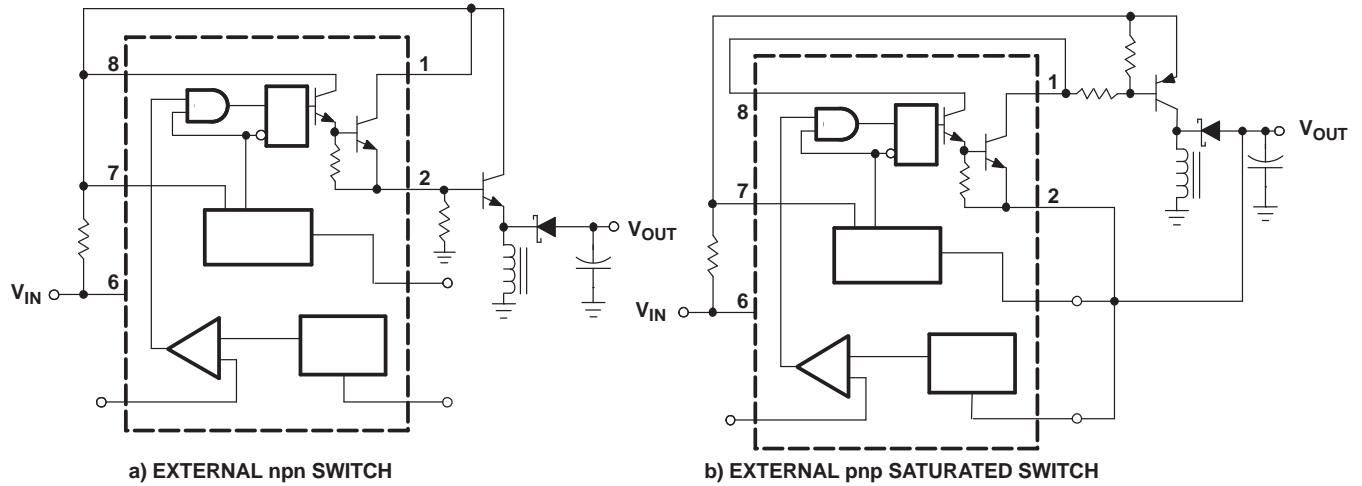


Figure 11. External Current-Boost Connections for  $I_C$  Peak Greater Than 1.5 A

**APPLICATION INFORMATION**

| CALCULATION          | STEP UP   | STEP DOWN   | VOLTAGE INVERTING   |
|----------------------|---|---|---|
| $t_{on}/t_{off}$     | $\frac{V_{out} + V_F - V_{in(min)}}{V_{in(min)} - V_{sat}}$                   | $\frac{V_{out} + V_F}{V_{in(min)} - V_{sat} - V_{out}}$                                 | $\frac{ V_{out}  + V_F}{V_{in} - V_{sat}}$                                    |
| $(t_{on} + t_{off})$ | $\frac{1}{f}$   | $\frac{1}{f}$   | $\frac{1}{f}$   |
| $t_{off}$            | $\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$                         | $\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$                                   | $\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$                         |
| $t_{on}$             | $(t_{on} + t_{off}) - t_{off}$  | $(t_{on} + t_{off}) - t_{off}$  | $(t_{on} + t_{off}) - t_{off}$  |
| $C_T$                | $4 \times 10^{-5} t_{on}$   | $4 \times 10^{-5} t_{on}$   | $4 \times 10^{-5} t_{on}$   |
| $I_{pk( switch )}$   | $2I_{out(max)} \left( \frac{t_{on}}{t_{off}} + 1 \right)$                     | $2I_{out(max)}$   | $2I_{out(max)} \left( \frac{t_{on}}{t_{off}} + 1 \right)$                     |
| $R_{sc}$             | $\frac{0.3}{I_{pk( switch )}}$  | $\frac{0.3}{I_{pk( switch )}}$  | $\frac{0.3}{I_{pk( switch )}}$  |
| $L_{(min)}$          | $\left( \frac{(V_{in(min)} - V_{sat})}{I_{pk( switch )}} \right) t_{on(max)}$ | $\left( \frac{(V_{in(min)} - V_{sat} - V_{out})}{I_{pk( switch )}} \right) t_{on(max)}$ | $\left( \frac{(V_{in(min)} - V_{sat})}{I_{pk( switch )}} \right) t_{on(max)}$ |
| $C_O$                | $9 \frac{I_{out} t_{on}}{V_{ripple(pp)}}$                                     | $\frac{I_{pk( switch )} (t_{on} + t_{off})}{8V_{ripple(pp)}}$                           | $9 \frac{I_{out} t_{on}}{V_{ripple(pp)}}$                                     |

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)         | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| MC33063AQDRQ1    | ACTIVE        | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | 33063AQ                  | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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**OTHER QUALIFIED VERSIONS OF MC33063A-Q1 :**

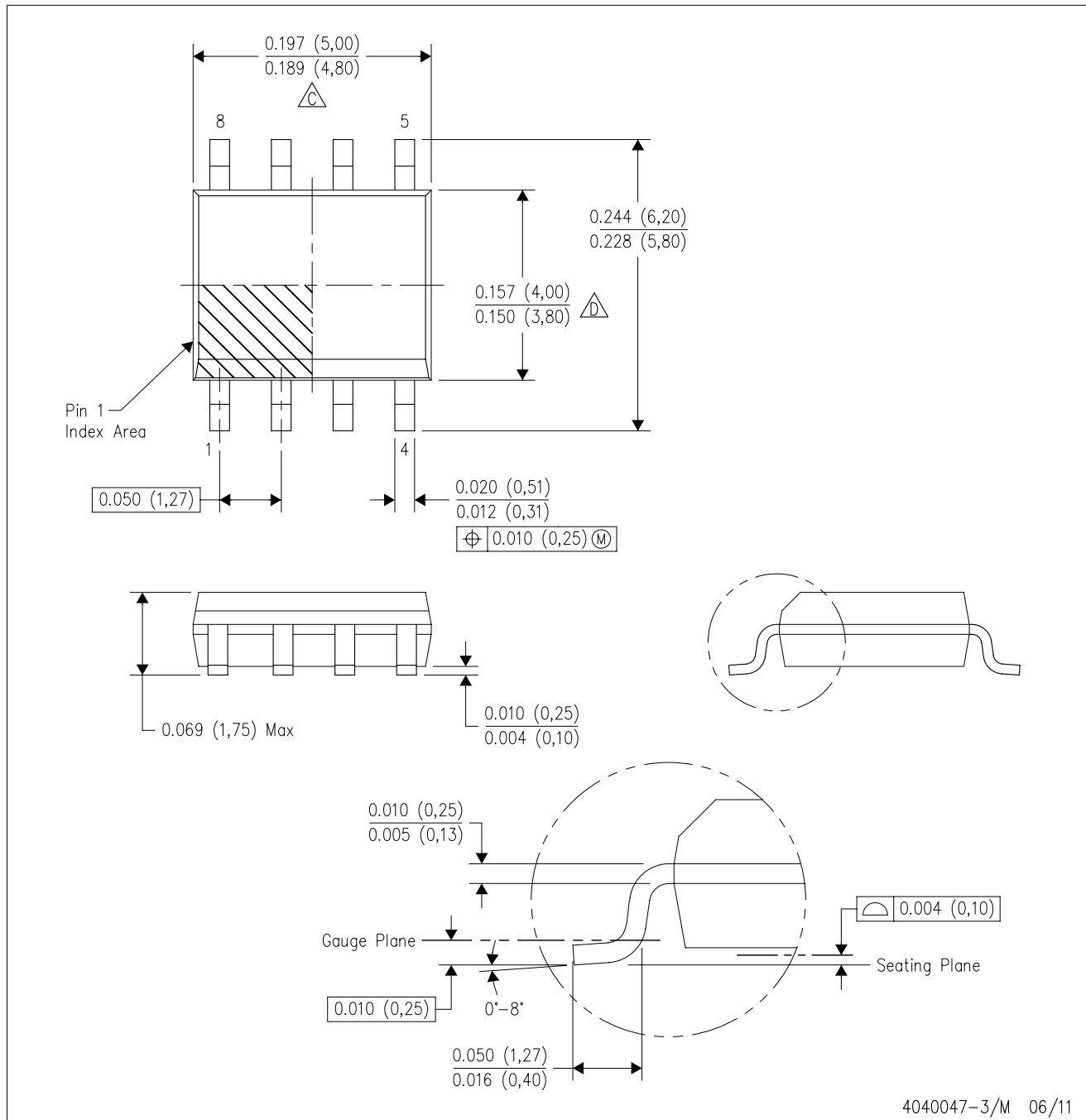
- Catalog: [MC33063A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

D (R-PDSO-G8)

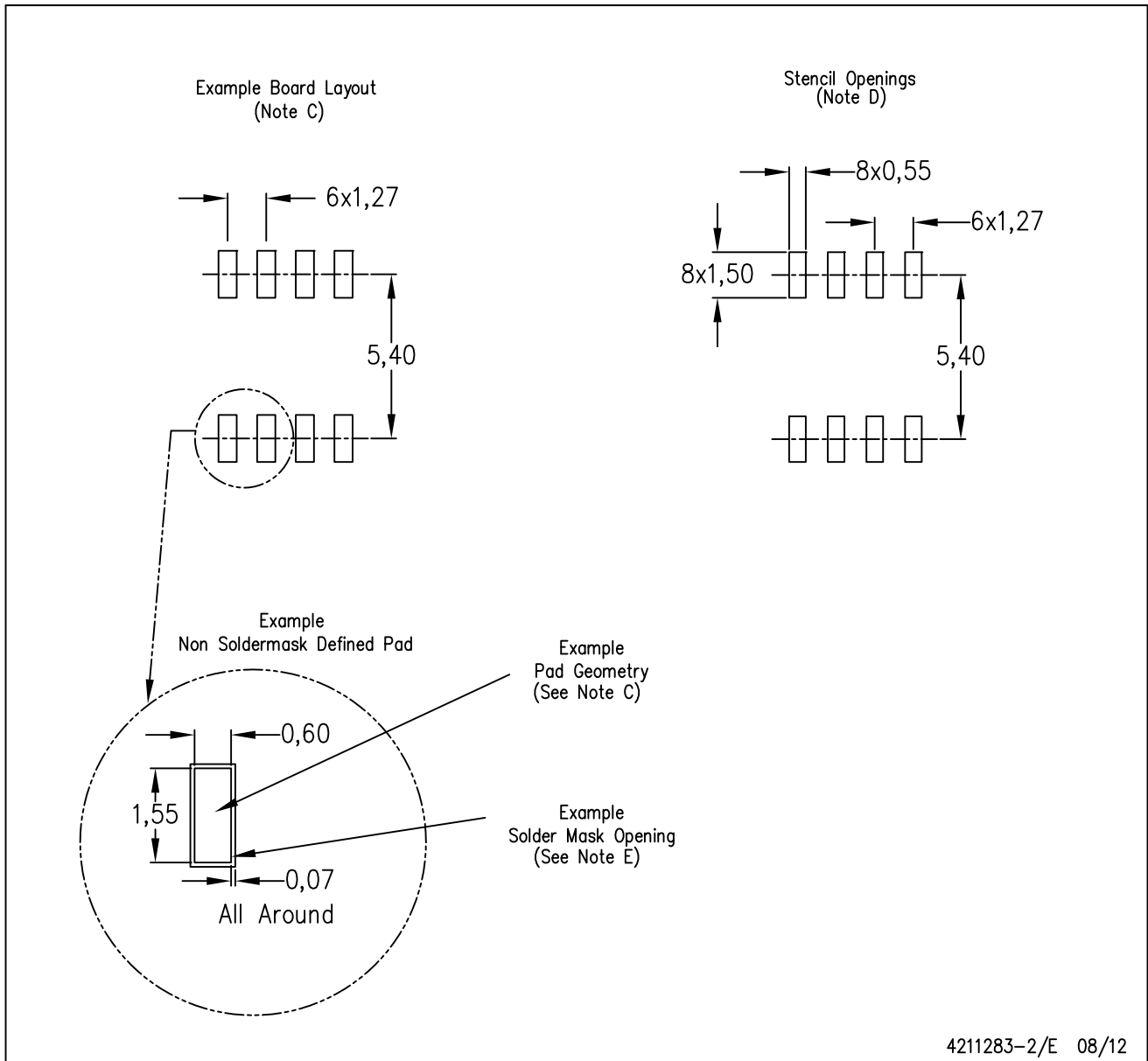
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

### Products

|                              |  |
|------------------------------|--|
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| Data Converters              | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>                       |
| DLP® Products                | <a href="http://www.dlp.com">www.dlp.com</a>   |
| DSP                          | <a href="http://dsp.ti.com">dsp.ti.com</a>   |
| Clocks and Timers            | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>                             |
| Interface                    | <a href="http://interface.ti.com">interface.ti.com</a>                               |
| Logic                        | <a href="http://logic.ti.com">logic.ti.com</a>                                       |
| Power Mgmt                   | <a href="http://power.ti.com">power.ti.com</a>                                       |
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| RFID                         | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Applications Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity        | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

### Applications

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| Computers and Peripherals     | <a href="http://www.ti.com/computers">www.ti.com/computers</a>                           |
| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
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